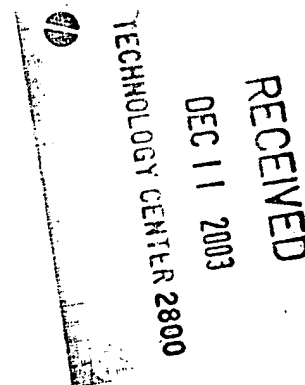


Application No. 10/074,988  
Amendment dated December 5, 2003  
Response to Notice of Non-Compliant Amendment dated November 24, 2003

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN THE APPLICATION OF : Jiangtao Wang et al.  
FOR : PROCESS FOR MANUFACTURING COPPER  
FOIL ON A METAL CARRIER SUBSTRATE  
SERIAL NO. : 10/074,988  
FILED : February 13, 2002  
CONFIRMATION NO. : 6876  
EXAMINER : Douglas M. Menz  
ART UNIT : 2824  
ATTORNEY DOCKET NO. : GD7376US



**MAIL STOP NON-FEE AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT (37 CFR 1.121)**

Dear Sir:

In response to the *Notice of Non-Compliant Amendment (37 CFR 1.121)* dated November 24, 2003, Applicant hereby submits a new "LISTING OF CLAIMS" section in connection with the above-identified U.S. patent application in accordance with item 4 in the *Notice* entitled: "Amendments to the claims."

**AMENDMENTS TO THE CLAIMS** are reflected in the listing of the claims which begins on page 2 of this Response.